



P3
4

save energy

keep track

anticipate

lower cost

save time

stay tuned

improve performance

feel secure



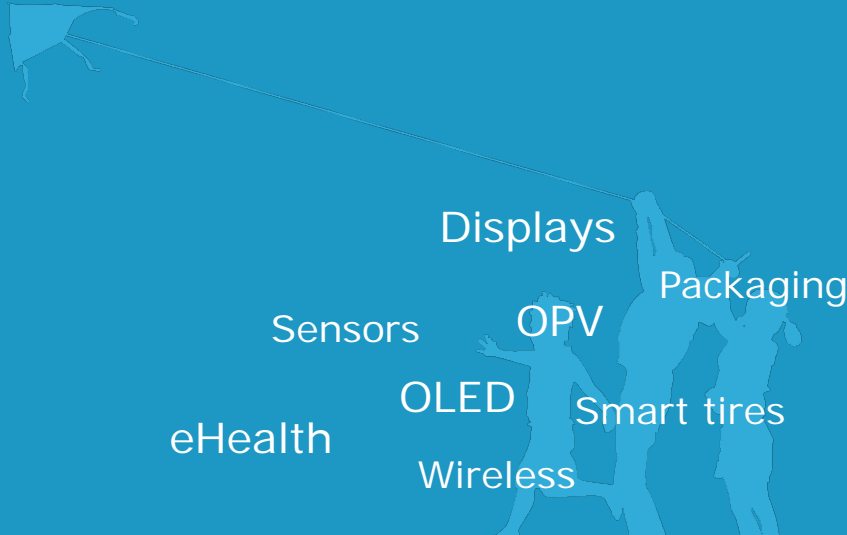
Holst Centre

Open Innovation by IMEC and TNO

Open innovation

Ultra-low-power, wireless & Flexible electronics

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Displays
Packaging
Sensors
OPV
Smart tires
eHealth
OLED
Wireless

Open Innovation on the High Tech Campus Eindhoven

- **Site-sharing:** >100 companies, >10000 researchers
- **Facility-sharing:** >8000m² cleanrooms, analysis equipment
- **Program Sharing:** Holst Centre

Holst Centre: Open Innovation in action

Who we are

- Independent R&D institute founded in 2005 by imec (BE) and TNO (NL)
- Own staff 210 researchers
- Located at the High Tech Campus in Eindhoven, The Netherlands

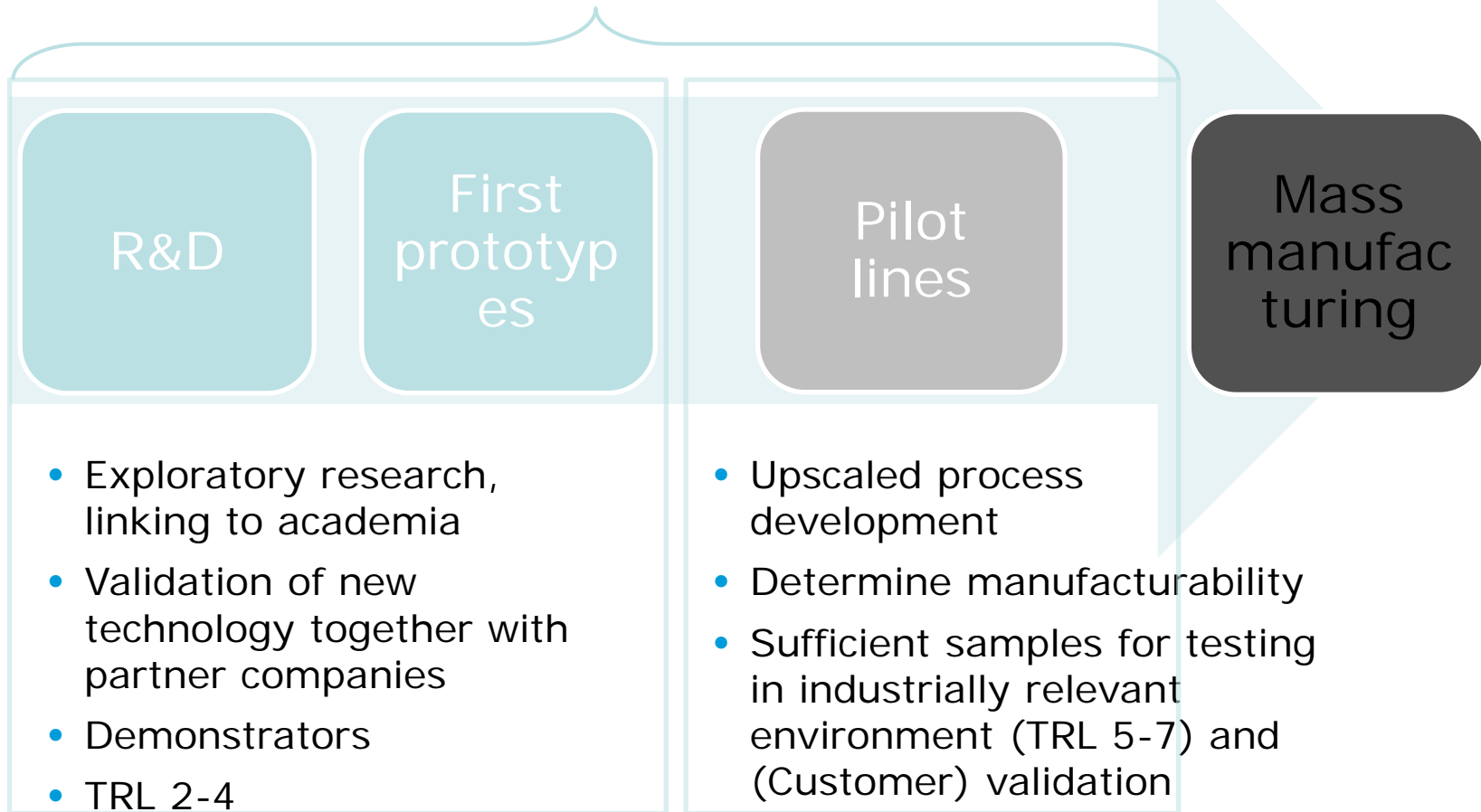


What we do

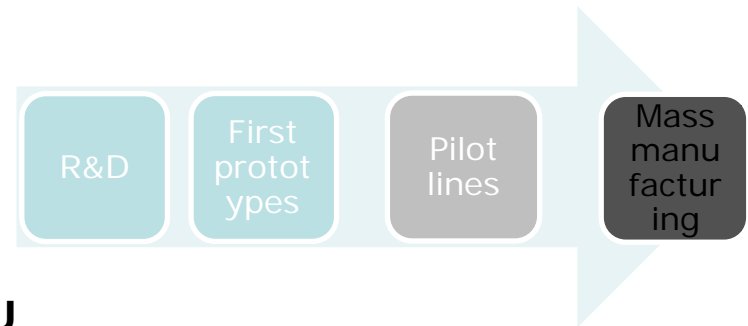
- Enabling technologies for **flexible electronics** and **wireless autonomous microsystems**, based on long term roadmaps
- In close collaboration with **leading industrial partners** along the value chain



Holst Centre: Bridging the gap from R&D to production



Holst Centre: Bridging the gap from R&D to production

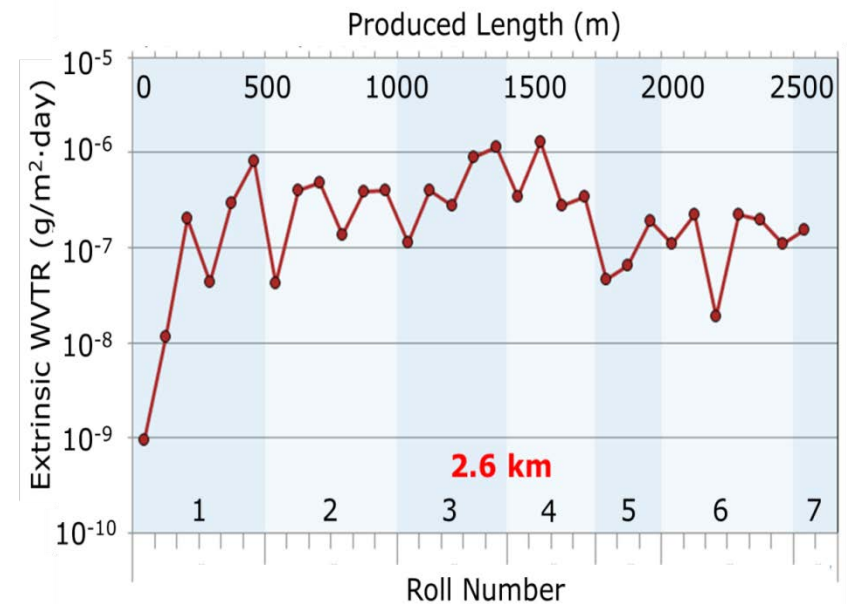


Primary goals:

- 1) **Creating R&D ecosystems in NL and EU**
 - Aligning roadmaps of key players
 - Supported by NL and EU funding
- 2) **Designing & building up pilot scale facilities and process capabilities at Holst Centre**
 - Increasing functionality, throughput, yield
 - Approaching TRL7
 - Offering pilot line services to Holst Centre partners
- 3) **Validating pilot lines with industrial cases at relevant volumes**

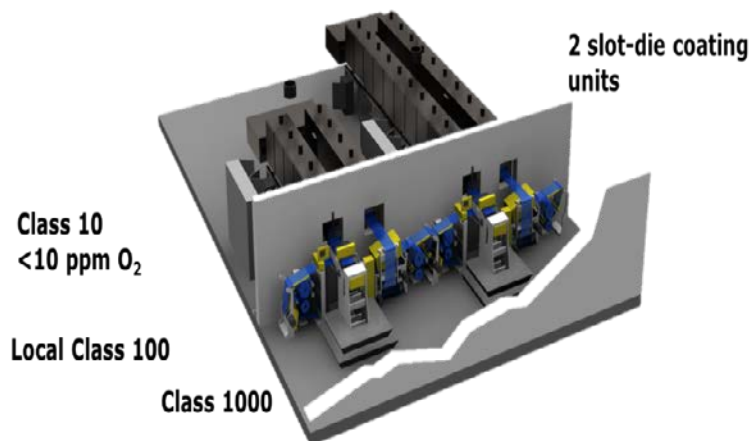
e.g. R2R moisture barrier film tool & process

- Production speed up to **4 m/min**, **PEN or PET plastic** web width **400 mm**, Total production so far **> 40 km**
- Pin hole density **< 0.1/cm²**, Extrinsic WVTR = **10⁻⁶ g/m²·day** at 20°C/50% RH for R2R barrier with **single inorganic layer**
- **Outperforms all commercially available** moisture barrier films in protection of OLEDs, OPV,...
- **Transferred to companies**



e.g. R2R solution processing of active layers and electrodes for OLEDs and OPV

- Coating speeds up to **30 m/min**, web width 400 mm, coating width **300 mm**
- **Two coating stations combined** in one pilot line, including drying ovens
- Web handling without ever touching the top side
- Closed ovens: **Class 10, O₂ and H₂O < 10 ppm**
- Slot-die coated layers of **100 - 30 nm** with thickness variation only **± 5 nm**
- Intermittent coating for patterning of layers with stabilisation within 5 mm



Building pilot line ecosystems in NL and EU Consortia

- Teaming up with leading companies and research institutes
- Defining, Building & Exploiting pilot lines both regional and European



PI-SCALE

SHAPING THE FUTURE IN OLED LIGHTING

www.pi-scale.eu



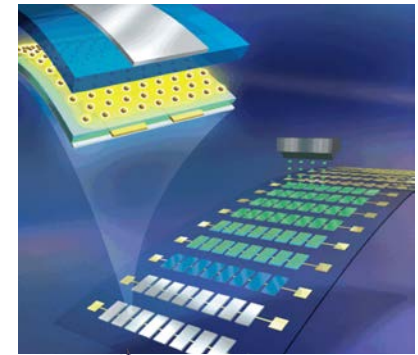
Flexible OLEDs



InSCOPE



Hybrid Electronics

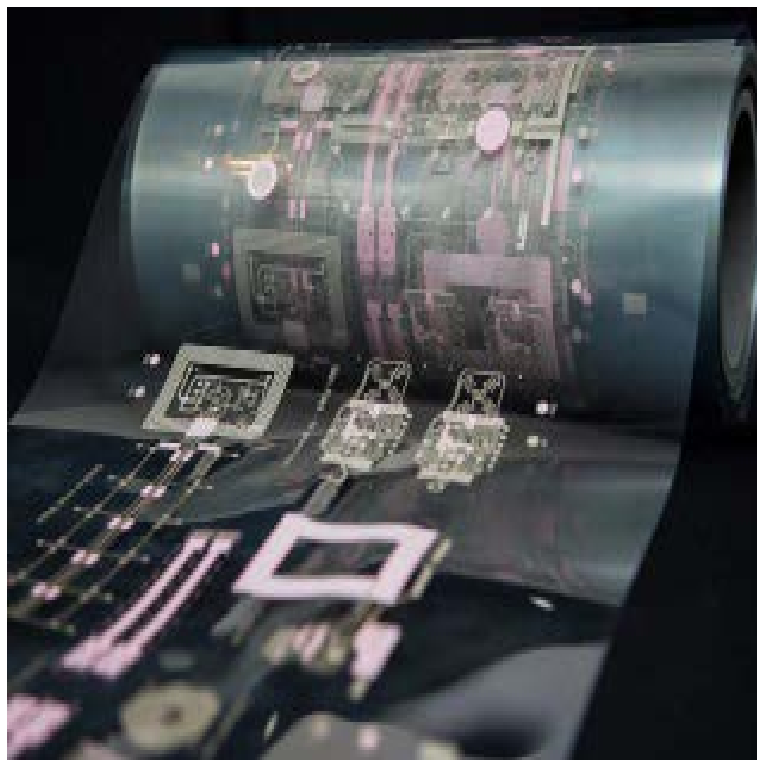


Thin Film Transistors

Technology platforms and pilot lines



***Pi-Scale:
Flexible OLEDs***



***InScope: Hybrid
Electronics***



***OpZuid: Thin
Film Transistors***

Example: Project PI-SCALE – Flexible OLEDs



- EU project receiving funding from the European Union's **Horizon 2020** research and innovation programme (grant agreement No. **688093**)
- **Flexible OLED pilot line services:**
 - Test and scale up new product ideas with customised designs
 - Assistance with processes to seamlessly integrate flexible OLEDs into products and to combine with other flexible electronics
 - Test new materials, substrates and processes

Example: Project PI-SCALE – Flexible OLEDs

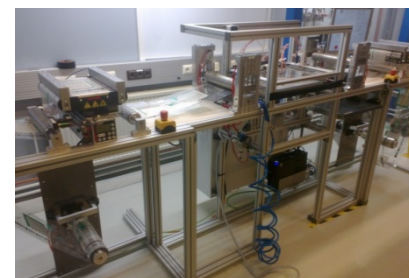


- Create an **independent, open access service** for fabrication of **flexible OLEDs** to **bridge the gap between R&D and mass production** which is **sustainable after finish of the EU project**
- Help to establish a **sustainable industry around flexible OLEDs** in Europe by increasing access to and awareness of this technology by scaled-up prototyping, hands-on workshops, design handbook and connection to regional development agencies

Distributed pilot line

PI-SCALE brings together existing European infrastructure into a

European flexible OLED pilot line



Coating Unit

Vacuum cluster

Encapsulation unit

Pi-Scale - Pilot line Services

Materials and equipment

Substrates
(DTF)

Moisture
barrier

Backplane
(FlexEnable)

OLED Material

Flexible
electronic
components

Equipment
(M-Solv,
Coatema)

Open access pilot line service

Infrastructure:
Holst Centre/TNO
Fraunhofer
VTT
CPI

Mass
Manufacturers

Applications / End users

Audi

Emde
Design

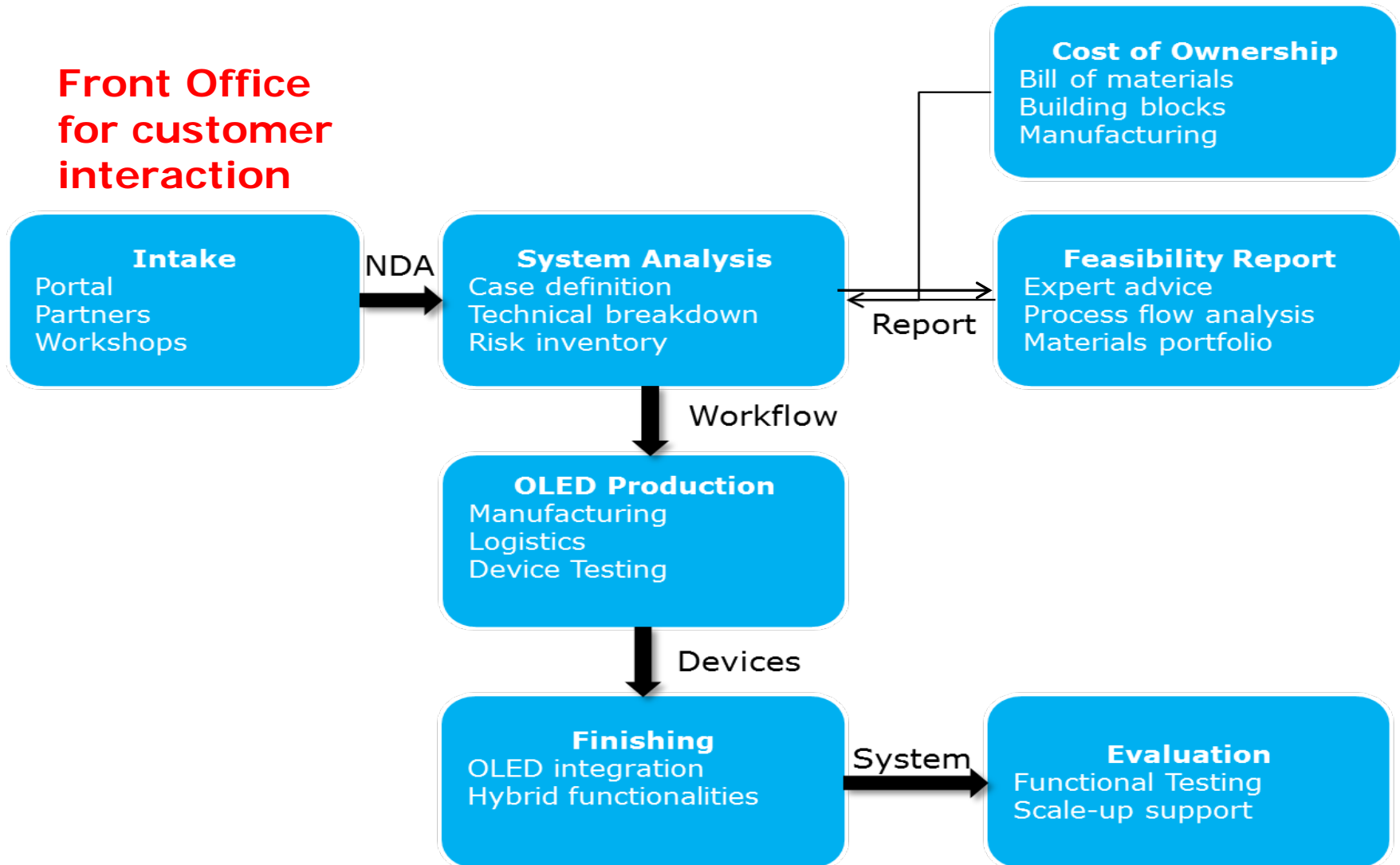
Rehau

Pilikington

End user

End user



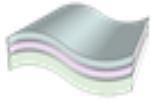
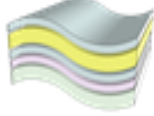
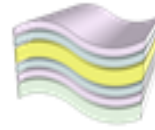

Pi-Scale Pilot line operations









Pi-Scale: Distributed pilot line process flows

Most mature process flows

Process flows under development

<p>e.g.</p> <p>R2REvaporated OLED</p> 								
	Bottom barrier	Anode & Structuring	OLED & Cathode	Encapsulation		Singulation	Characterization and testing	System integration
	<i>Holst, ext. sup.</i>	<i>FhG</i>	<i>FhG</i>	<i>FhG</i>		<i>FhG, CPI</i>	<i>Holst, FhG</i>	<i>VTT</i>
HC R2R barrier, thin glass	ITO, ISO printing	OLED and Cathode evaporation	Lamination of HC R2R barrier	Roll slitting and cutting	Acc. shelf lifetime; Device el. characterization;	Component assembly, inj. molding ...		

R2R evaporated OLED

							
R2REvaporated OLED	Bottom barrier	Anode & Structuring	OLED & Cathode	Encapsulation	Singulation	Characterization and testing	System integration
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	HC R2R barrier, thin glass	ITO, ISO printing	OLED and Cathode evaporation	Lamination of HC R2R barrier	Roll slitting and cutting	Acc. shelf lifetime; Device el. characterization;	Component assembly, inj. molding ...

Make the optimum combination of available know-how & infrastructure

Fully roll-to-Roll evaporated OLEDs

R2R moisture barrier



+

R2R OLED evaporation

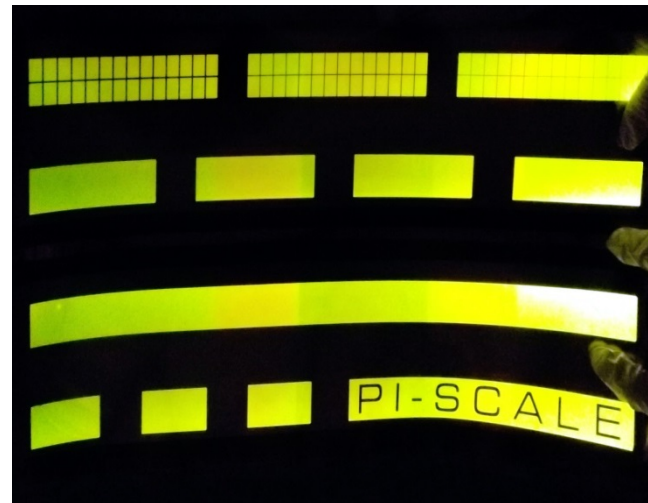


+

R2R lamination of barrier film



30 cm
wide



15 m length in one run

- Combining know how & infrastructure of European RTO's
- Combine best in class
- Performance & Features beyond current commercial offering

Flexible Sheet-to-Sheet OLEDs from PI-SCALE



Substrate size: 0.2 x 0.2 m

Flexible Roll-to-Roll OLEDs from PI-SCALE



Sample length: 2 m
Roll length: 15 m

Features offered

2017

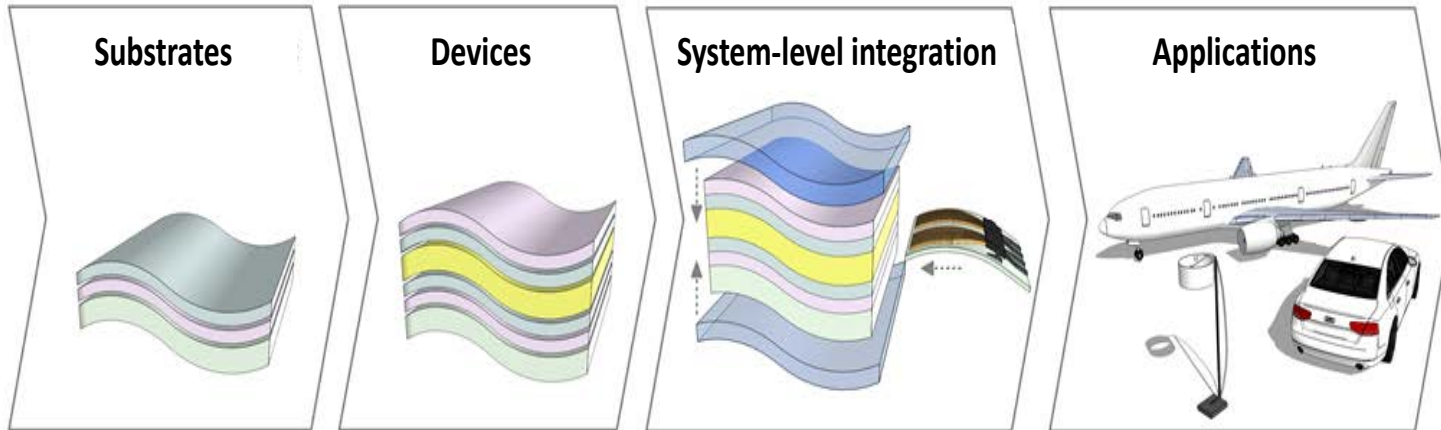
- **Highest flexibility**
 - Bending radius down to 10 mm
- **Most colors**
 - Red, Green, Blue, Orange, Yellow, Magenta, Cyan, White, ...
- **Ultra-thin**
 - Thickness 0.2 mm
- **Any shape and design**
 - Fully customized

2018

- **Any size**
 - Length >15 m



Making the pilot scale facilities and capabilities more mature



One point to connect to:

- Suppliers of materials & Equipment
- Knowhow of RTO's on manufacturing & integration
- Mass manufacturers & end-users

Reaching out to Partners in Open Innovation



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